

## RUGGED LATCHING HIGH-SPEED SYSTEM

EYE®
SPEEDHD
I/O SYSTEM



(0.80 mm) .0315" PITCH • ERI8/ERC SERIES

ERI8
Mates:
EPLSP

SPECIFICATIONS

Insulator Material: Black LCP Terminal Material: BeCu Plating:

Plating: Au or Sn over 50 μ" (1.27 μm) Ni Current Rating: 1.7 A per pin (2 pins powered)

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Voltage Rating:
225 VAC/320 VDC
Operating Temp Range:
-55 °C to +125 °C

## **PROCESSING**

Lead-Free Solderable: Yes SMT Lead Coplanarity: (0.10 mm) .004" max ERI8 - NO. OF POSITIONS

**-019** = 9 Pairs, 5 Power, 19 positions

**-031** = 17 Pairs, 5 Power, 31 positions **-**S

**PLATING** 

OPTION

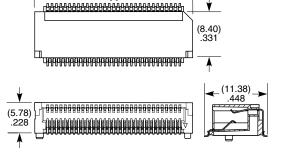
= 30 µ" (0.76 µm) Gold on contact, Matte Tin on tail **-TR** = Tape & Reel

OTHER OPTION

-FR = Full Reel Tape & Reel (must order max. quantity per reel; contact Samtec

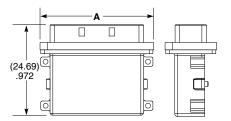
for quantity breaks)

NO. OF POSITIONS	Α
-019	(19,08) .751
-031	(28.68) 1.13



View complete specifications at: samtec.com?ERI8





NO. OF POSITIONS	Α
-019	(30.55) 1.203
-031	(40.15) 1.58

= With Gasket

View complete specifications at: samtec.com?ERC

## Notes:

Active equalization reference design for Eye Speed® I/O system see www.samtec.com?EPLSP

Some lengths, styles and options are non-standard, non-returnable.